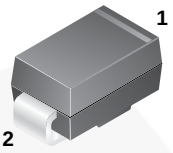
August 2015

SSA210
Surface Mount Schottky Barrier Rectifier

Features

- UL Flammability 94V-0 Classification
- MSL 1
- RoHS Compliant / Green Mold Compound
- Industrial Device Qualified per AEC-Q101 Standards.
  * see authorized use policy



SMA/DO-214AC

COLOR BAND DENOTES CATHODE

Ordering Information

Part Number	Top Mark	Package	Packing Method
SSA210	SSA210	DO-214AC (SMA)	Tape and Reel

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at T_A = 25°C unless otherwise noted.

Symbol	Parameter	Value	Unit
V_{RRM}	Recurrent Peak Reverse Voltage	100	V
V_{RMS}	RMS Voltage	70	V
V_{DC}	DC Blocking Voltage	100	V
$I_{F(AV)}$	Average Forward Current	2	A
I_{FSM}	Peak Forward Surge Current: 8.3 ms Single Half Sine-Wave Superimposed on Rated Load (JEDEC Method)	50	A
T_J	Operating Junction Temperature Range	-55 to +175	°C
T_{STG}	Storage Temperature Range	-55 to +175	°C

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Thermal Characteristics[1]

Values are at T_A = 25°C unless otherwise noted.

Symbol	Parameter	Value	Unit
ψ_{JL}	Typical Thermal Characteristics, Junction-to-Lead[2]	30	°C/W
$R_{\theta JA}$	Typical Thermal Resistance, Junction-to-Ambient	180	°C/W

Note:

1. Per JESD51-3 recommended thermal test board. Device mounted on FR-4 PCB, board size = 76.2 mm x 114.3 mm.
2. Thermocouple soldered at cathode lead.

Electrical Characteristics

Values are at T_A = 25°C unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V_F	Forward Voltage[3]	I_F = 2.0 A			0.8	V
I_R	Reverse Current	V_R = 100 V			0.05	mA
		V_R = 100 V, T_A = 100°C			20	
T_{rr}	Reverse Recovery Time	I_F = 0.5 A, I_R = 1 A, I_{rr} = 0.25 A		8.02		ns

Note:

3. Pulse test with Pulse width = 300 μs, 1% duty cycle.

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Typical Performance Characteristics

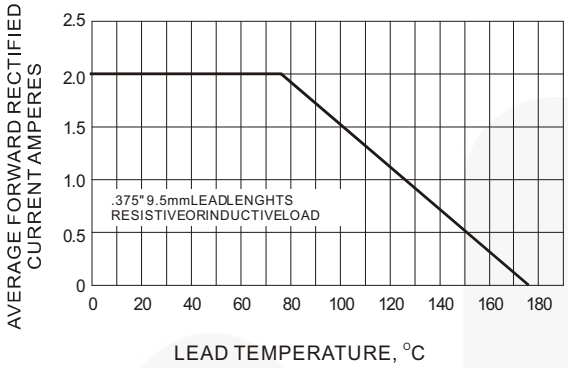

Figure 1. Forward Current Derating Curve

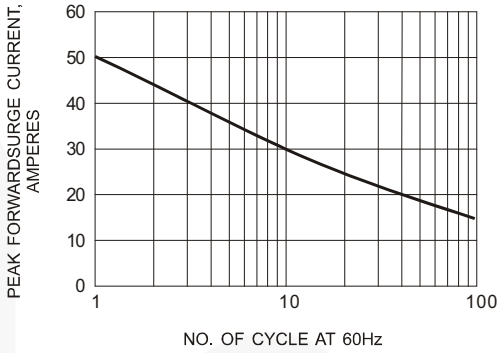

Figure 2. Maximum Non-Repetitive Peak Forward Surge Current

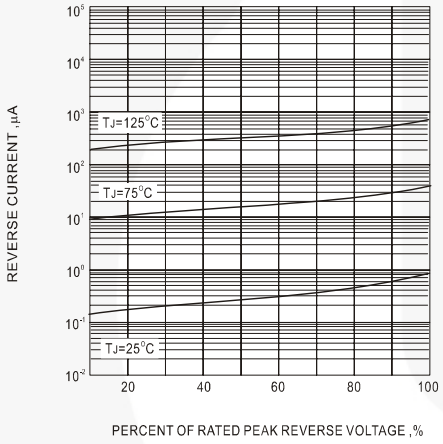

Figure 3. Typical Reverse Characteristic

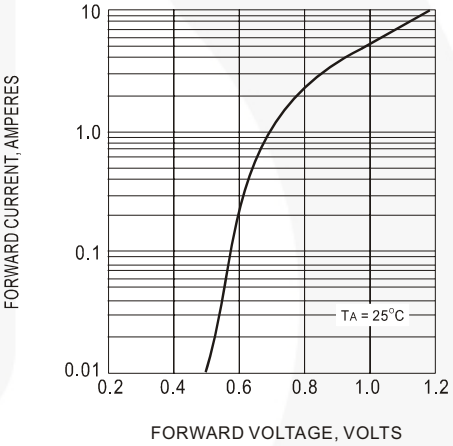

Figure 4. Typical Instantaneous Forward Characteristics

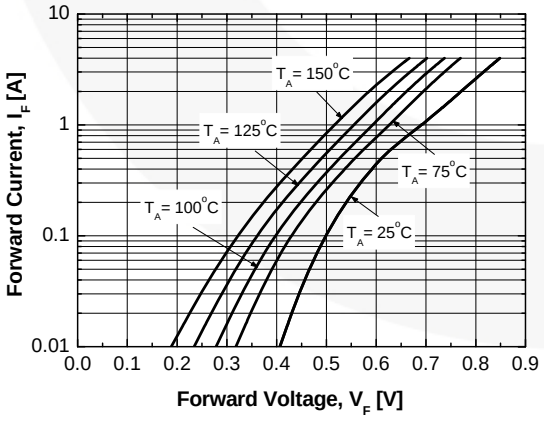

Figure 5. Typical Forward Characteristics

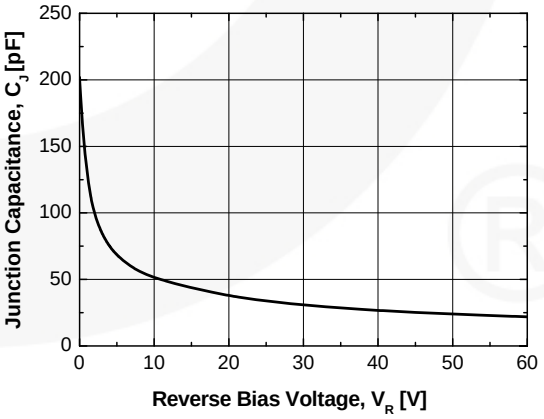

Figure 6. Typical Junction Capacitance

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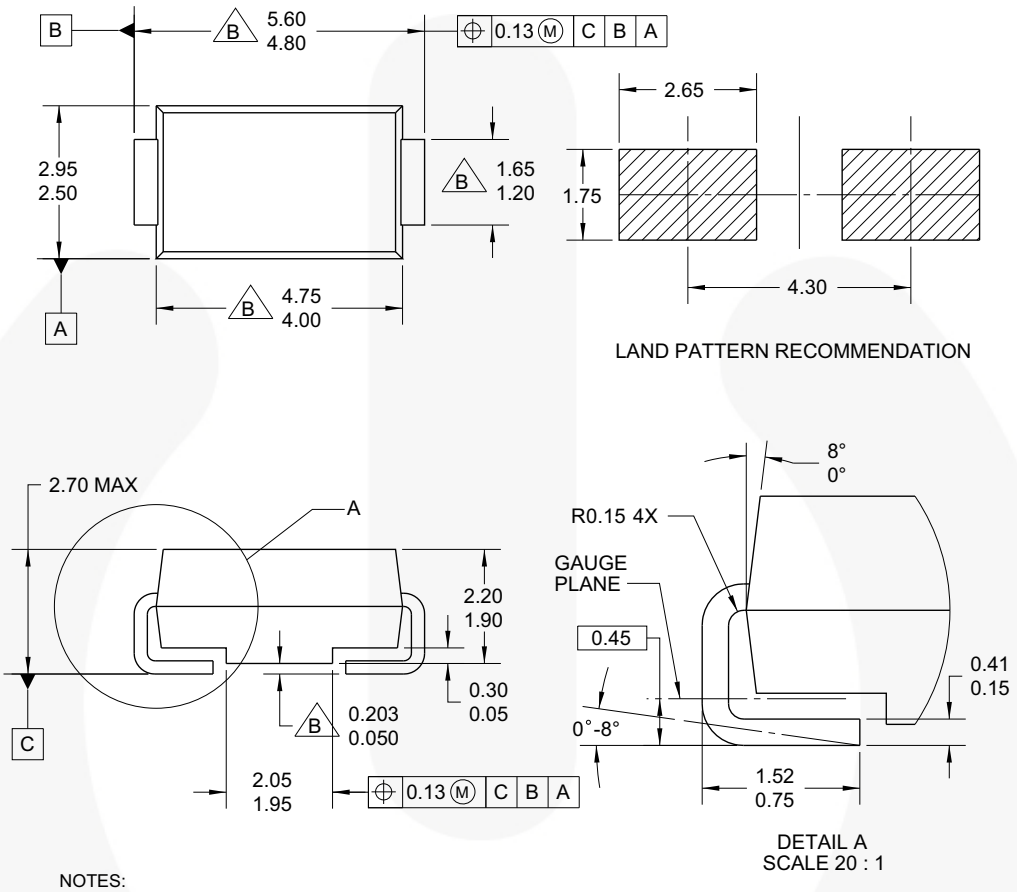
Physical Dimensions



NOTES:

A. EXCEPT WHERE NOTED CONFORMS TO JEDEC DO214 VARIATION AC.
B DOES NOT COMPLY JEDEC STD. VALUE.
C. ALL DIMENSIONS ARE IN MILLIMETERS.
D. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.
E. DIMENSION AND TOLERANCE AS PER ASME Y14.5-1994.
F. LAND PATTERN STD. DIOM5025X231M.
G. DRAWING FILE NAME: DO214ACREV1

Figure 7. 2-LEAD, SMA, JEDEC DO-214, VARIATION AC

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